

| L Number | Hits | Search Text | DB | Time stamp |
|----------|--------|--|---|------------------|
| - | 0 | ("ferroelectric adj memory").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/03 08:31 |
| - | 0 | ("insulat\$ and substrate and contact adj hole and (burry buried)").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/03 08:33 |
| - | 3514 | ferroelectric adj memory | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/03 08:34 |
| - | 0 | insulat\$3 and substrate and contact adj hole and (burry and burried) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/08 12:24 |
| - | 0 | insulat\$3 and substrate and (burry and burried) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/03 08:36 |
| - | 337972 | insulat\$3 and substrate | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/03 08:36 |
| - | 1091 | (ferroelectric adj memory) and (insulat\$3 and substrate) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/03 08:36 |
| - | 923 | ((ferroelectric adj memory) and (insulat\$3 and substrate)) and capacitor | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/03 08:37 |
| - | 330 | ((((ferroelectric adj memory) and (insulat\$3 and substrate)) and capacitor) and contact adj hole | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/03 08:37 |
| - | 3 | ((((ferroelectric adj memory) and (insulat\$3 and substrate)) and capacitor) and contact adj hole) and blocking adj layer | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/08 12:13 |
| - | 12043 | kwon.in. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/03 08:53 |
| - | 12043 | kwon-s.in. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/03 08:53 |
| - | 134 | kwon-s-y.in. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/03 08:54 |
| - | 134 | 'kwon, s y'.in. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/03 09:22 |

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|---|----|--|---|------------------|
| - | 29 | ((257/295,298,310,532).CCLS.) and buried near3 contact) and ferroelectric and plug with (tungsten 'W') | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/10/08 17:03 |
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